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C.F.  
7/24/01

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Beilin et al.

Serial No.: Unassigned

Filed: Herewith

For: METHODS OF PLANARIZING  
STRUCTURES ON WAFERS  
AND SUBSTRATES BY POLISHING

Examiner: S. Ahmed

Group Art Unit: 1746

Attorney Docket: 25916-111 (53755)

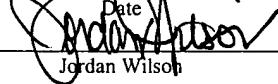
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June 12, 2001

By   
Jordan Wilson

Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

Please enter the following Preliminary Amendment to the accompanying patent  
application:

**In The Specification:**

On page 1, line 3, before 'FIELD OF THE INVENTION', insert the following  
paragraph:

*A* This application is a continuation application of copending applications having Serial  
No. 09/259,125, filed February 26, 1999. Application Serial No. 09/259,125 is a continuation  
application of application having Serial No. 08/717,266, filed on September 20, 1996. Benefit of  
all earlier filing dates is claimed.